

RF360 Europe GmbH
A Qualcomm – TDK Joint Venture

Data sheet

SAW duplexer LTE band 2

Series/type: B1244

Ordering code: B39202B1244P810

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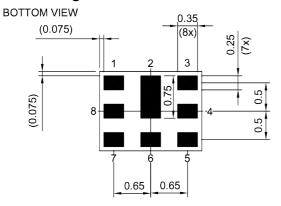
1 Application

- Low-loss SAW duplexer for mobile telephone LTE Band 2 (PCS) systems.
- Low insertion attenuation
- Low amplitude ripple
- Usable pass band 60 MHz

2 Features

- Package size 1.8±0.1 mm × 1.4±0.1 mm
- Package height 0.475 mm (max.)
- Approximate weight 3 mg
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 3 (MSL3)

3 Package



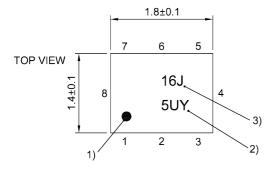
Pad and pitch tolerance ±0.05

4 Pin configuration

- 1 RX
- 13 TX
- 6 ANT
- **2**, 4, 5, 7, Ground 8

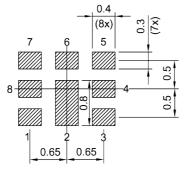
SIDE VIEW





- 1) Marking for pad number 1
- 2) Example of encoded lot number
- 3) Example of encoded filter type number





Landing pad tolerance -0.02

Figure 1: Drawing of package with package height A = 0.475 mm (max.). See Sec. Package information (p. 25).

5 Matching circuit

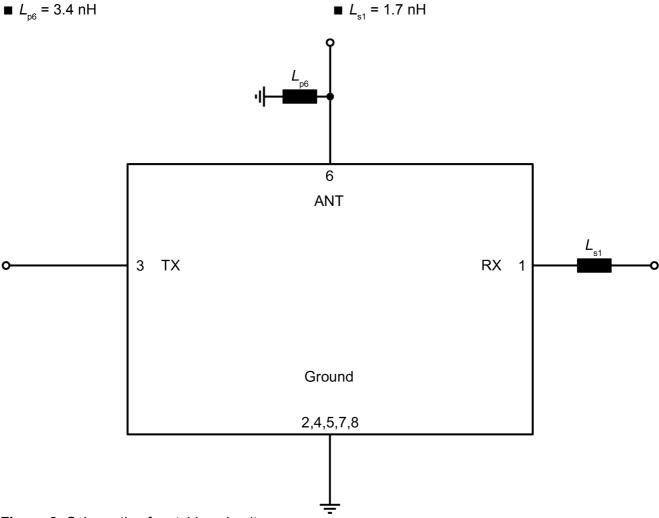


Figure 2: Schematic of matching circuit.

External shunt inductor for ESD protection is recommended at any ports towards antenna.



6 Characteristics

6.1 TX - ANT

Temperature range for specification $T_{\text{SPEC}} = -30 \,^{\circ}\text{C} \dots +85 \,^{\circ}\text{C}$

TX terminating impedance $Z_{TX} = 50 \Omega$

ANT terminating impedance $Z_{ANT} = 50 \Omega$ with par. 3.4 nH¹⁾ RX terminating impedance $Z_{RX} = 50 \Omega$ with ser. 1.7 nH¹⁾

Characteristics TX – ANT ²⁾				$\begin{array}{c} \textbf{min.} \\ \textbf{for } T_{\text{SPEC}} \end{array}$	typ. @ +25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{\tiny SPEC}} \end{array}$	
Center frequency			f _C	_	1880	_	MHz
Maximum insertion attenuation							
	1850 1910	MHz	$\alpha_{\text{INT,max}}^{ 3)}$	_	1.5	2.4	dB
	1850.24 1909.76	MHz	α_{max}	_	1.7	2.4	dB
Maximum VSWR			VSWR _{max}				
@ TX port	1850.24 1909.76	MHz		_	1.6	2.0	
@ ANT port	1850.24 1909.76	MHz		_	1.5	2.0	
Minimum attenuation			$\boldsymbol{\alpha}_{\text{min}}$				
	10 894	MHz		44	46	_	dB
	1226 1250	MHz		40	42	_	dB
	1559 1605.9	MHz		42	44	_	dB
	1605.8 1680	MHz		40	47	_	dB
	1930.24 1989.76	MHz		45	55	_	dB
	2010 2025	MHz		40	50	_	dB
	2110 2155	MHz		40	44	_	dB
	2400 2500	MHz		25	35	_	dB
	3700 3820	MHz		28	33	_	dB
	4900 5850	MHz		19	23	_	dB
	5254 5455	MHz		22	25	_	dB
	5540 5950	MHz		17	22	_	dB

See Sec. Matching circuit (p. 6).

²⁾ Specified min/max values are valid for a testing power of +10 dBm.

Integrated attenuation α_{INT} : Averaged power $|S_{ii}|^2$ over the center 4.5 MHz of LTE 5 MHz (25 RB) channels.



6.2 ANT - RX

= -30 °C ... +85 °C Temperature range for specification $T_{\scriptscriptstyle{\mathrm{SPEC}}}$

TX terminating impedance $= 50 \Omega$

ANT terminating impedance = 50 Ω with par. 3.4 nH¹⁾ RX terminating impedance = 50 Ω with ser. 1.7 nH¹⁾

Characteristics ANT – RX ²⁾				$\begin{array}{c} \text{min.} \\ \text{for } T_{\text{SPEC}} \end{array}$	typ. @ +25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{SPEC}} \end{array}$	
Center frequency			f _C	_	1960	_	MHz
Maximum insertion attenuation							
	1930 1990	MHz	$\alpha_{\text{INT,max}}^{ 3)}$	_	2.2	3.0	dB
	1930.24 1989.76	MHz	$\boldsymbol{\alpha}_{\text{max}}$	_	2.4	3.04)	dB
	1930.24 1989.76	MHz	$\boldsymbol{\alpha}_{\text{max}}$		2.4	3.25)	dB
Maximum VSWR			VSWR _{max}				
@ ANT port	1930.24 1989.76	MHz		_	1.6	2.0	
@ RX port	1930.24 1989.76	MHz		_	1.5	2.0	
Minimum attenuation			$\boldsymbol{\alpha}_{\text{min}}$				
	10 1100	MHz		45	49	_	dB
	80	MHz		50	70	_	dB
	1100 1850	MHz		41	45	_	dB
	1850.24 1909.76	MHz		45	50	_	dB
	2050 2075	MHz		35	42	_	dB
	2075 2305	MHz		30	34	_	dB
	2305 2315	MHz		40	50	_	dB
	2315 2550	MHz		15	20	_	dB
	2550 6000	MHz		40	45	_	dB

See Sec. Matching circuit (p. 6).

²⁾

Specified min/max values are valid for a testing power of +10 dBm. Integrated attenuation α_{INT} : Averaged power $|S_{ij}|^2$ over the center 4.5 MHz of LTE 5 MHz (25 RB) channels. 3)

⁴⁾ Valid for temperature $T = +25 \,^{\circ}\text{C...} + 85 \,^{\circ}\text{C.}$

Valid for temperature $T = -30 \,^{\circ}\text{C...} + 25 \,^{\circ}\text{C.}$



6.3 TX - RX

= -30 °C ... +85 °C Temperature range for specification T_{SPEC}

TX terminating impedance $= 50 \Omega$

ANT terminating impedance = 50 Ω with par. 3.4 nH¹⁾ RX terminating impedance = 50 Ω with ser. 1.7 nH¹⁾

Characteristics TX – RX ²⁾				$\begin{array}{c} \text{min.} \\ \text{for } T_{\text{SPEC}} \end{array}$	typ. @ +25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{SPEC}} \end{array}$	
Minimum isolation							
	1574 1577	MHz	$\boldsymbol{\alpha}_{\text{min}}$	55	63	_	dB
	1850 1910	MHz	$\alpha_{\text{INT,min}}^{ 3)}$	54	56	_	dB
	1850.24 1909.76	MHz	$\boldsymbol{\alpha}_{\text{min}}$	53 ⁴⁾	56	_	dB
	1850.24 1909.76	MHz	$\boldsymbol{\alpha}_{\text{min}}$	51	56	_	dB
	1930 1990	MHz	$\alpha_{\text{INT,min}}^{ 3)}$	55	60	_	dB
	1930.24 1989.76	MHz	$\boldsymbol{\alpha}_{\text{min}}$	55 ⁵⁾	60	_	dB
	1930.24 1989.76	MHz	$\boldsymbol{\alpha}_{\text{min}}$		60	_	dB
	3700 3820	MHz	α_{min}	45	52	_	dB
	5550 5850	MHz	$\boldsymbol{\alpha}_{\text{min}}$	42	50	_	dB

See Sec. Matching circuit (p. 6).

Specified min/max values are valid for a testing power of +10 dBm.

Integrated attenuation α_{INT} : Averaged power $|S_{ij}|^2$ over the center 4.5 MHz of LTE 5 MHz (25 RB) channels. Valid for temperature T = -30 °C...+25 °C. Valid for temperature T = +25 °C...+85 °C.



7 Maximum ratings

Storage temperature	T _{STG} ¹⁾ = −40 °C +90 °C	
DC voltage	$ V_{DC} ^{3)} = 0 \text{ V (max.)}^{2)}$	
ESD voltage		
	$V_{\rm ESD}^{4)} = 50 \text{ V (max.)}$	Machine model.
	$V_{\rm ESD}^{5)} = 300 \text{V (max.)}$	Human body model.
	$V_{ESD}^{6)} = 600 \text{ V (max.)}$	Charged device model.
Input power @ TX port: 1850.24 1909.76 MHz	P _{IN} = 30 dBm	Continuous wave for 5000 h @ 50 °C.

Not valid for packaging material. Storage temperature for packaging material is −25 °C to +40 °C.

²⁾ 168h Damp Heat Steady State acc. IEC 60068-2-67 Cy.

³⁾ In case of applied DC voltage blocking capacitors are mandatory.

According to JESD22-A115B (MM – Machine Model), 10 negative & 10 positive pulses.

⁵⁾ According to JESD22-A114F (HBM – Human Body Model), 1 negative & 1 positive pulse.

⁶⁾ According to JESD22-C101C (CDM – Field Induced Charged Device Model), 3 negative & 3 positive pulses.

8 Transmission coefficients

8.1 TX - ANT 0.0 1.0 2.0 .665 1.68 3.0 4.0 5.0 1860 1920 1880 1900 1840 f/MHz0.0 20.0 40.0 60.0 80.0 <u>+</u> 1750 1800 1850 1900 2050 1950 2000 2100 f/MHz 0.0 20.0 40.0 60.0 80.0 1000 2000 3000 4000 5000 6000 f/MHz

Figure 3: Attenuation TX – ANT.

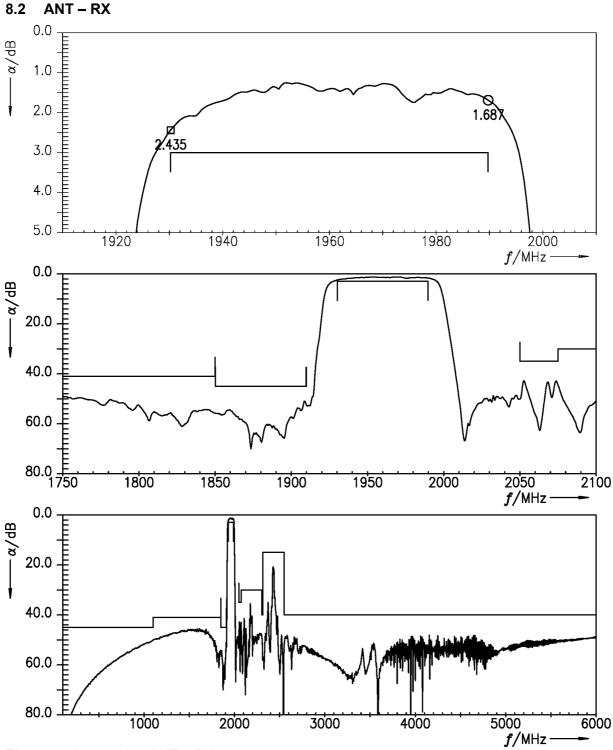


Figure 4: Attenuation ANT – RX.

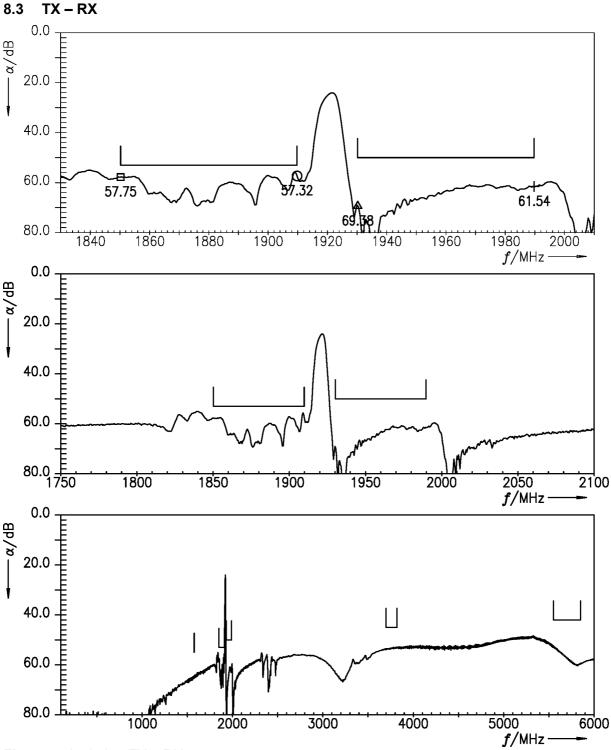


Figure 5: Isolation TX – RX.

9 Transmission coefficients (LTE)

9.1 TX - ANT 0.0 $-\alpha_{INT}/dB$ 1.0 1.48 1.561 2.0 3.0 4.0 5.0 1860 1920 1880 1900 1840 f/MHz0.0 20.0 40.0 60.0 80.0 <u>+</u> 1750 1800 1850 1900 1950 2000 2050 2100 f/MHz 0.0 $-\alpha_{INT}/dB$ 20.0 40.0 60.0 80.0 1000 2000 3000 4000 5000 6000

Figure 6: Attenuation (LTE) (integration window = 5 MHz) TX – ANT.

f/MHz

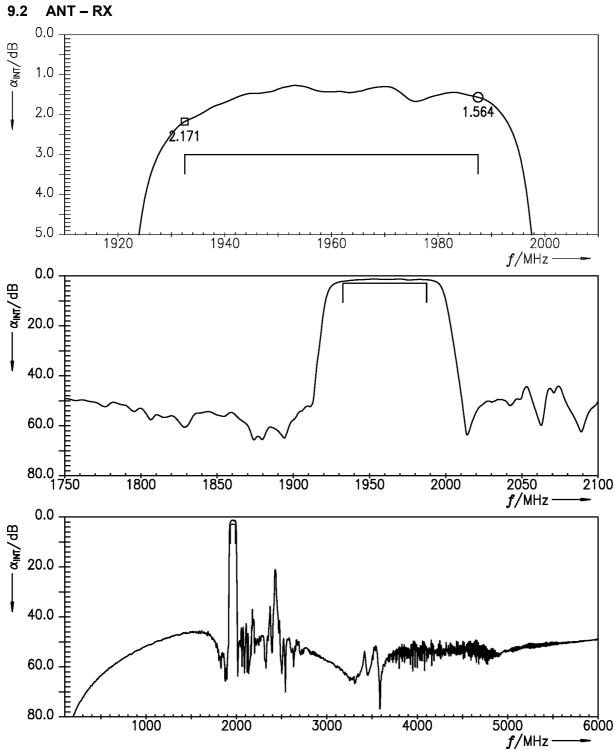


Figure 7: Attenuation (LTE) (integration window = 5 MHz) ANT – RX.

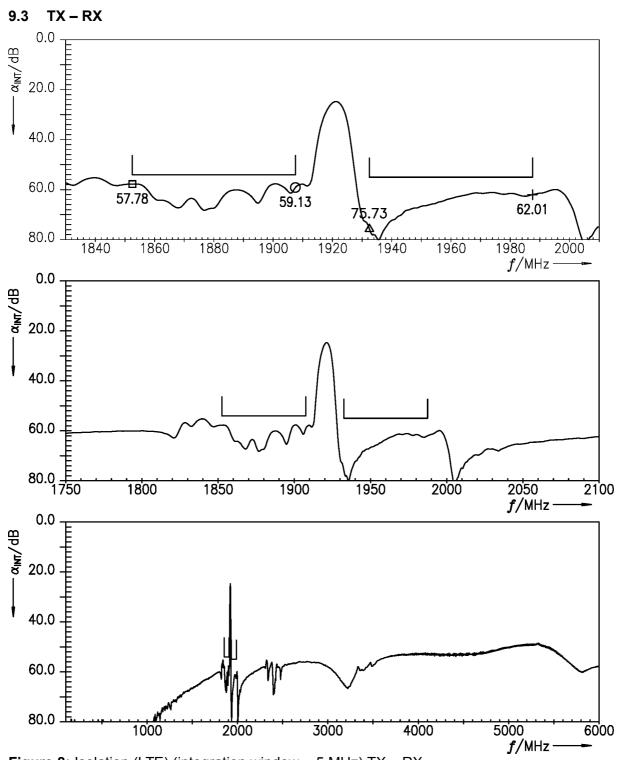
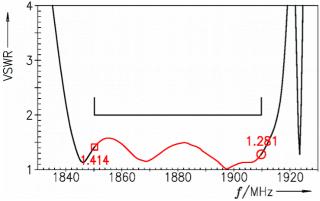


Figure 8: Isolation (LTE) (integration window = 5 MHz) TX – RX.

10 Reflection coefficients



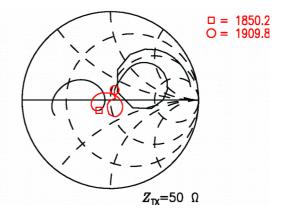
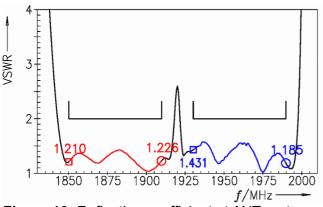


Figure 9: Reflection coefficient at TX port.



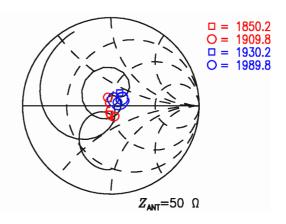
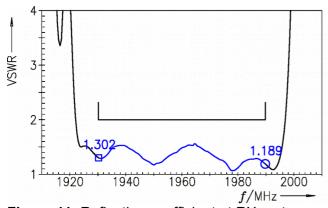


Figure 10: Reflection coefficient at ANT port.



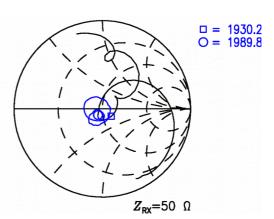


Figure 11: Reflection coefficient at RX port.

11 Packing material

11.1 Tape

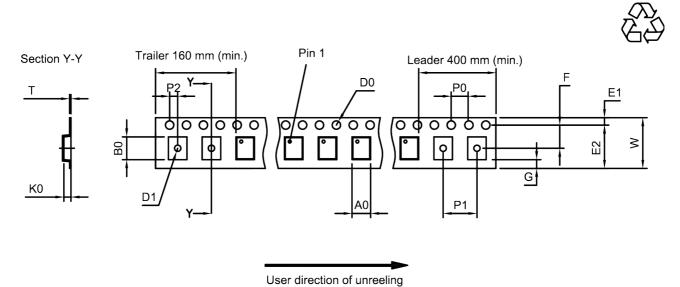


Figure 12: Drawing of tape (first-angle projection) with tape dimensions according to Table 1.

A ₀	1.62±0.05 mm	E ₂	6.25 mm (min.)	P	4.0±0.1 mm
B ₀	2.04±0.05 mm	F	3.5±0.05 mm	P	2.0±0.05 mm
D ₀	1.5+0.1/-0 mm	G	0.75 mm (min.)	T	0.25±0.05 mm
D ₁	0.8±0.05 mm	K ₀	0.62±0.05 mm	W	8.0±0.1 mm
E ₁	1.75 _{±0.1} mm	P ₀	4.0±0.1 mm		

Table 1: Tape dimensions.

11.2 Reel with diameter of 180 mm

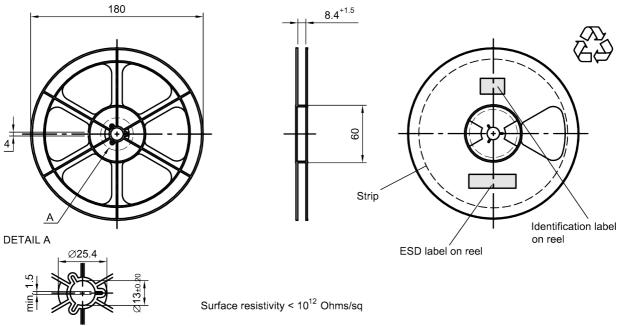


Figure 13: Drawing of reel (first-angle projection) with diameter of 180 mm.

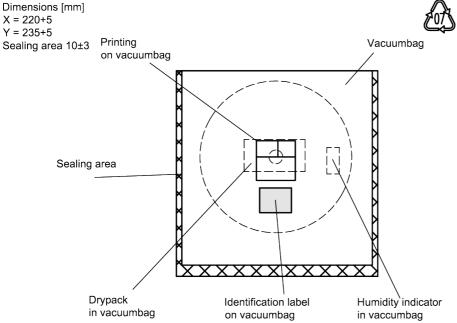


Figure 14: Drawing of moisture barrier bag (MBB) for reel with diameter of 180 mm.

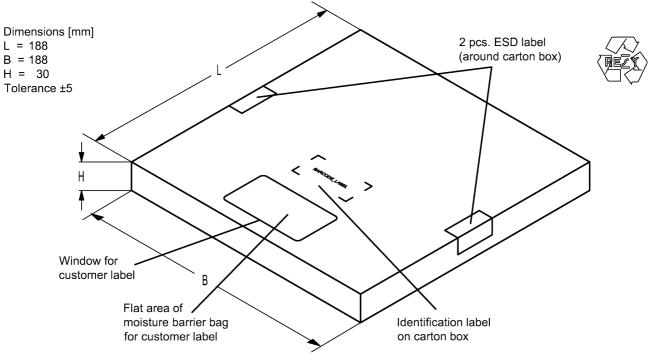


Figure 15: Drawing of folding box for reel with diameter of 180 mm.

11.3 Reel with diameter of 330 mm

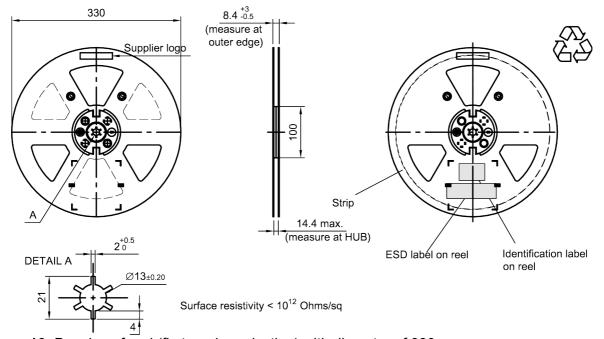


Figure 16: Drawing of reel (first-angle projection) with diameter of 330 mm.

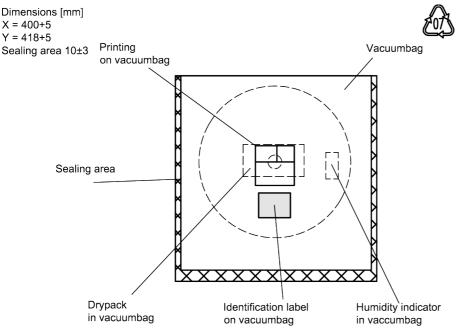


Figure 17: Drawing of moisture barrier bag (MBB) for reel with diameter of 330 mm.

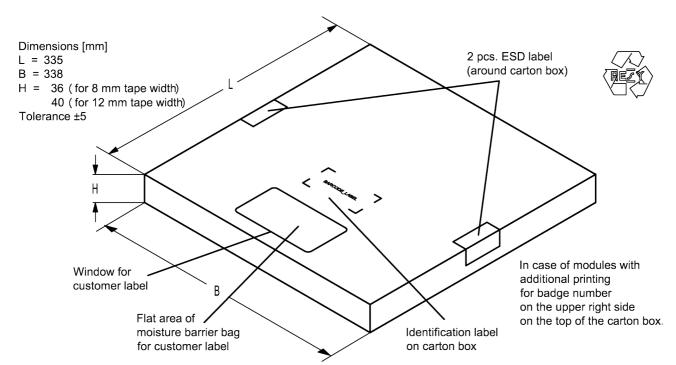


Figure 18: Drawing of folding box for reel with diameter of 330 mm.



12 Marking

Products are marked with product type number and lot number encoded according to Table 2:

■ Type number:

The 4 digit type number of the ordering code, e.g., B3xxxxB1234xxxx, is encoded by a special BASE32 code into a 3 digit marking.

Example of decoding type number marking on device in decimal code.

16J 1234 1 x 32^2 + 6 x 32^1 + 18 (=J) x 32^0 1234

The BASE32 code for product type B1244 is 16W.

■ Lot number:

The last 5 digits of the lot number, 12345, are encoded based on a special BASE47 code into a 3 digit marking.

Example of decoding lot number marking on device in decimal code.

12345 => 5 x 47^2 + 27 (=U) x 47^1 + 31 (=Y) x 47^0 12345

Adopted BASE32 code for type number							
Decimal value	Base32 code	Decimal value	Base32 code				
0	0	16	G				
1	1	17	Н				
2	2	18	J				
3	3	19	K				
4	4	20	M				

value	code	value	code
0	0	16	G
1	1	17	Н
2	2	18	J
3	3	19	K
4	4	20	M
5	5	21	N
6	6	22	Р
7	7	23	Q
8	8	24	R
9	9	25	S
10	Α	26	Т
11	В	27	V
12	С	28	W
13	D	29	Х
14	E	30	Y
15	F	31	Z

Adopted BASE47 code for lot number						
Decimal	Base47	Decimal	Base47			
value	code	value	code			
0	0	24	R			
1	1	25	S			
2	2	26	Т			
3	3	27	U			
4	4	28	V			
5	5	29	W			
6	6	30	X			
7	7	31	Y			
8	8	32	Z			
9	9	33	b			
10	Α	34	d			
11	В	35	f			
12	С	36	h			
13	D	37	n			
14	E	38	r			
15	F	39	t			
16	G	40	V			
17	Н	41	\			
18	J	42	?			
19	K	43	{			
20	L	44	}			
21	М	45	<			
22	N	46	>			
23	Р					

Table 2: Lists for encoding and decoding of marking.

13 Soldering profile

The recommended soldering process is in accordance with IEC $60068-2-58-3^{rd}$ edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
T > 220 °C	30 s to 70 s
T > 230 °C	min. 10 s
T > 245 °C	max. 20 s
<i>T</i> ≥ 255 °C	-
peak temperature T_{peak}	250 °C +0/-5 °C
wetting temperature T _{min}	230 °C +5/-0 °C for 10 s ± 1 s
cooling rate	≤ 3 K/s
soldering temperature <i>T</i>	measured at solder pads

Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).

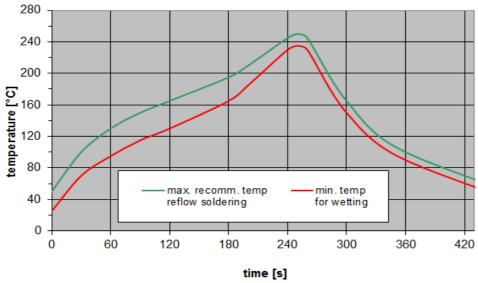


Figure 19: Recommended reflow profile for convection and infrared soldering – lead-free solder.



14 Annotations

14.1 Matching coils

See TDK inductor pdf-catalog http://www.tdk.co.jp/tefe02/coil.htm#aname1 and Data Library for circuit simulation http://www.tdk.co.jp/etvcl/index.htm.

14.2 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

14.3 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.

14.4 Ordering codes and packing units

Ordering code	Packing unit
B39202B1244P810	15000 pcs
B39202B1244P810S 5	5000 pcs

Table 4: Ordering codes and packing units.



15 Cautions and warnings

15.1 Display of ordering codes for RF360 products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of RF360, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under www.rf360jv.com/orderingcodes.

15.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

15.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

15.4 Package information

Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Projection method

Unless otherwise specified first-angle projection is applied.



16 Important notes

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, RF360 Europe GmbH and its affiliates are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an RF360 product with the properties described in the product specification is suitable for use in a particular customer application.
- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
- 3. The warnings, cautions and product-specific notes must be observed.
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